PD-90492E

IRFM440

JANTX2N7222

JANTXV2N7222



POWER MOSFET THRU-HOLE (TO-254AA)

Product Summary

Part Number	R _{DS(on)}	I _D		
IRFM440	0.85Ω	8.0A		

Description

HEXFET MOSFET technology is the key to IR HiRel advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high trans conductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heat sink. This improves thermal efficiency and reduces drain capacitance.

Absolute Maximum Ratings

	Parameter		Units
I _D @ V _{GS} = 10V, T _C = 25°C	Continuous Drain Current	8.0	
$I_D @ V_{GS} = 10V, T_C = 100^{\circ}C$	Continuous Drain Current	5.0	А
I _{DM}	Pulsed Drain Current ①	32	
P _D @T _C = 25°C	Maximum Power Dissipation	125	W
	Linear Derating Factor	1.0	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy ②	700	mJ
I _{AR}	Avalanche Current ①	8.0	А
E _{AR}	Repetitive Avalanche Energy ①	12.5	mJ
dv/dt	Peak Diode Recovery dv/dt 3	3.5	V/ns
TJ	Operating Junction and	-55 to + 150	
T _{STG}	Storage Temperature Range		°C
	Lead Temperature	300 (0.063 in. /1.6 mm from case for 10s)	
	Weight	9.3 (Typical)	g

For Footnotes refer to the page 2.

500V, N-CHANNEL REF: MIL-PRF-19500/596 HEXFET MOSFET TECHNOLOGY



Features

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light Weight
- ESD Rating: Class 2 per MIL-STD-750, Method 1020



Electrical Characteristics	@ T _j =	25°C (Unless	Otherwise	Specified)
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	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	500			V	$V_{GS} = 0V, I_{D} = 1.0mA$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.78		V/°C	Reference to 25°C, $I_D = 1.0$ mA
D	Static Drain-to-Source On-State			0.85	0	V _{GS} = 10V, I _D = 5.0A ④
►DS(on)	Resistance			0.95	52	V _{GS} = 10V, I _D = 8.0A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Gfs	Forward Transconductance	4.7			S	V _{DS} = 15V, I _D = 5.0A ④
I _{DSS}	Zero Gate Voltage Drain Current			25		V_{DS} = 400V, V_{GS} = 0V
	Zero Gale voltage Drain Current			250	μΛ	$V_{DS} = 400V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Leakage Forward			100	nΛ	V _{GS} = 20V
	Gate-to-Source Leakage Reverse			-100		V _{GS} = -20V
Q _G	Total Gate Charge			68.5		I _D = 8.0A
Q _{GS}	Gate-to-Source Charge			12.5	nC	V _{DS} = 250V
Q _{GD}	Gate-to-Drain ('Miller') Charge			42.4		V _{GS} = 10V
t _{d(on)}	Turn-On Delay Time			21		V _{DD} = 250V
tr	Rise Time			73		I _D = 8.0A
t _{d(off)}	Turn-Off Delay Time			72	ns	R _G = 9.1Ω
t _f	Fall Time			51		V _{GS} = 10V
Ls +L _D	Total Inductance		6.8		nH	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package) with Source wire internally bonded from Source pin to Drain pad
C _{iss}	Input Capacitance		1300			$V_{GS} = 0V$
C _{oss}	Output Capacitance		310		pF	V _{DS} = 25V
C _{rss}	Reverse Transfer Capacitance		120			f = 1.0MHz

Source-Drain Diode Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
I _S	Continuous Source Current (Body Diode)			8.0	^	
I _{SM}	Pulsed Source Current (Body Diode) ①			32	A	
V _{SD}	Diode Forward Voltage			1.5	V	$T_J = 25^{\circ}C, I_S = 8.0A, V_{GS} = 0V$
t _{rr}	Reverse Recovery Time			700	ns	$T_J = 25^{\circ}C, I_F = 8.0A, V_{DD} \le 50V$
Q _{rr}	Reverse Recovery Charge			8.9	μC	di/dt = 100A/µs ④
t _{on}	Forward Turn-On Time	Intrins	ic turn-c	on time i	s negligib	le (turn-on is dominated by $L_{S}+L_{D}$)

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
R _{0JC}	Junction-to-Case			1.0	
R _{0CS}	Case -to-Sink		0.21		°C/W
$R_{ ext{ heta}JA}$	Junction-to-Ambient (Typical socket mount)			48	

Footnotes:

- $\ensuremath{\mathbb O}$ Repetitive Rating; Pulse width limited by maximum junction temperature.
- $@~V_{\text{DD}}$ = 50V, starting T_{J} = 25°C, L = 21.8mH, Peak I_L = 8.0A, V_{GS} = 10V
- $I_{SD} \leq 8.0A, di/dt \leq 100A/\mu s, V_{DD} \leq 500V, T_J \leq 150^{\circ}C$





Fig 1. Typical Output Characteristics



Fig 3. Typical Transfer Characteristics



Drain-to-Source Voltage



Fig 2. Typical Output Characteristics



Fig 4. Normalized On-Resistance Vs. Temperature



Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage





Fig 7. Typical Source-Drain Diode Forward Voltage



Fig 9. Maximum Drain Current Vs. Case Temperature



Fig 8. Maximum Safe Operating Area



Fig 10. Maximum Avalanche Energy Vs. Drain Current







Fig 12a. Unclamped Inductive Test Circuit



Fig 13a. Basic Gate Charge Waveform



Fig 14a. Switching Time Test Circuit







Fig 13b. Gate Charge Test Circuit



Fig 14b. Switching Time Waveforms



Case Outline and Dimensions - TO-254AA



BERYLLIA WARNING PER MIL-PRF-19500

Package containing beryllia shall not be ground, sandblasted, machined, or have other operations performed on them which will produce beryllia or beryllium dust. Furthermore, beryllium oxide packages shall not be placed in acids that will produce fumes containing beryllium.



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